



Micron  
Technology, Inc.  
8000 S.  
Federal Way  
PO Box 6  
Boise, ID  
United States

## LPDDR3 DRAM V01M 8Gb based Wafer Fabrication Site Transfer to Fab 6

**PCN: 33454**

**Published: 2020-06-29**

### **Revision History:**

**REVISION 1, 2020-10-05:** This revision supersedes the original PCN 33454 dated 2020-06-29.

**NOTE:** Sample Available, Qual Data Available and the below listed dates have been updated in the record detail

Product Ship Date from 2020-10-29 to 2021-01-03

Last Purchase Date from 2021-01-30 to 2021-04-05

Last Shipment Date from 2021-07-31 to 2021-10-05

---

<b>Type:</b>	Manufacturing Site - Change or Addition
<b>Description:</b>	Micron is transferring Wafer Fabrication for the below listed products as follows:  <b>Current Fab Site:</b> Micron Memory Japan Inc. (Fab 15), 7-10 Yoshikawa Kogyo Danchi, Higashihiroshima-Shi, Hiroshima, Japan

---

**New Fab Site:** Micron Technology, Inc. (Fab 6), 9600 Godwin Dr, Manassas, Virginia

\*Last purchase and shipment dates below are applicable to the availability of the product from the current fab site, Fab 15.

---

**Reason:** Manufacturing Efficiency, Supply Flexibility/Security

---

**Product Affected:** LPDDR3 DRAM V01M 8Gb / 16Gb / 32Gb

---

<b>Affected Micron Part Number</b>	<b>Recommended Replacement</b>	<b>Customer Part Number</b>
------------------------------------	--------------------------------	-----------------------------

Component

MT52L1G32D4PG-093 WT:B		
------------------------	--	--

MT52L1G32D4PG-107 WT:B		
------------------------	--	--

<b>MT52L256M32D1PF-107 WT:B</b>		?
---------------------------------	--	---

MT52L256M64D2FT-107 WT:B		
--------------------------	--	--

MT52L256M64D2LZ-107 WT:B		
--------------------------	--	--

MT52L512M32D2PF-093 WT:B		
--------------------------	--	--

<b>MT52L512M32D2PF-107 WT:B</b>		?
---------------------------------	--	---

MT52L512M32D2PU-107 WT:B		
--------------------------	--	--

MT52L768M32D3PU-107 WT:B		
--------------------------	--	--

Wafer

MT52L256M32D1V01MWC1		
----------------------	--	--

\*Materials that have been ordered are in **bold**.

---

**Method of Identification:** Refer to Micron's Customer Service Note CSN-11 (Product Marks, Product Labels, and Packaging Labels): "FAB 6" will appear on the inner packing container label.

---

**Micron Sites Affected:** Fab 6 - US

---

**Sample Available:** 2020-10-05

---

**Qual Data Available:** 2020-11-20

---

**Product Ship Date:** 2021-01-03

---

**Last Purchase Date\*:** 2021-04-05

---

**Last Shipment Date:** 2021-10-05

Early placement of orders is encouraged as an increase in demand for this product could potentially exceed Micron's ability to meet all requests. All products from a previously accepted order that have not shipped as of the last-time purchase date will be considered non-cancelable and non-returnable. Changes to confirmed request dates will also require written approval by Micron. Should

additional supply be available after the last-time purchase date, Micron may accept orders for product and such orders placed will be considered non-cancelable and non-returnable.

NOTE: Per JEDEC Standard JESD46-C Section 3.2.3; lack of acknowledgment of this PCN within 30 days constitutes acceptance of change.